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Automotive P-Channel 80 V (D-S) 175 °C MOSFET

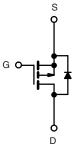


PRODUCT SUMMARY V_{DS} (V) -80 $R_{DS(on)}(\Omega)$ at $V_{GS} = -10$ V 0.0195 $R_{DS(on)}(\Omega)$ at $V_{GS} = -4.5 V$ 0.0290 I_D (A) ^g -62 Configuration Single

FEATURES

- TrenchFET[®] power MOSFET
- AEC-Q101 qualified
- 100 % R_q and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912





P-Channel MOSFET

ORDERING INFORMATION						
	Package	PowerPAK [®] SO-8L				
	Lead (Pb)-free and halogen-free	SQJ185ELP (for detailed order number please see <u>www.vishay.com/doc?79771</u>)				

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage Gate-source voltage ^a		V _{DS}	-80		
		V _{GS}	± 20	V	
Continuous drain current ^g	T _C = 25 °C ^b	- I _D	-62		
	T _C = 125 °C		-35		
Continuous source current (diode conduction) ^{b, g} Pulsed drain current ^{c, g}		I _S	90	А	
		I _{DM}	-145		
Single pulse avalanche current		I _{AS}	41		
Single pulse avalanche energy	L = 0.1 mH	E _{AS}	84	mJ	
	T _C = 25 °C	D	145	W	
Maximum power dissipation ^{c, g}	T _C = 125 °C	P _D	48	vv	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	°C	
Soldering recommendations (peak temperature) d, e		-	260	-0	

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	LIMIT	UNIT		
Junction-to-ambient	PCB mount ^e	R _{thJA}	42	- °C/W		
Junction-to-case (drain) ^f		R _{thJC}	1.03			

Notes

a. Not intended for continuous use with positive gate voltage > 5.0 V

b. Package limited

- c.
- When mounted on 1" square PCB (FR4 material) See solder profile (<u>www.vishay.com/doc?73257</u>). For PowerPAK SO-8L, the end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to d. ensure adequate bottom side solder interconnection Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 % As per on JESD51-14

f.

Values based on RthJC and TC of 25 °C. Actual values achievable will be dependent on the thermal characteristics of the complete system g.

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0, I_D = -250 \ \mu A$		-80	-	-	V
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$		-2.0	-2.5	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$		-	-	± 100	nA
		$V_{GS} = 0 V$	V _{DS} = -80 V	-	-	-1	μA
Zero gate voltage drain current	I _{DSS}	$V_{GS} = 0 V$	V_{DS} = -80 V, T _J = 125 °C	-	-	-50	
		$V_{GS} = 0 V$	V _{DS} = -80 V, T _J = 175 °C	-	-	-150	
On-state drain current ^a	I _{D(on)}	V _{GS} = -10 V	$V_{DS} \ge -5 V$	-30	-	-	Α
	R _{DS(on)}	V _{GS} = -10 V	I _D = -10 A	-	0.0165	0.0195	
		V _{GS} = -10 V	I _D = -10 A, T _J = 125 °C	-	-	0.0315	Ω
Drain-source on-state resistance ^a		V _{GS} = -10 V	I _D = -10 A, T _J = 175 °C	-	-	0.0380	
		V _{GS} = -4.5 V	I _D = -8 A	-	0.0240	0.0290	
Forward transconductance b	g _{fs}	V _{DS} =	-15 V, I _D = -10 A	-	32	-	S
Dynamic ^b							
Input capacitance	C _{iss}		V _{DS} = -25 V, f = 1 MHz	-	3510	4914	pF
Output capacitance	C _{oss}	$V_{GS} = 0 V$		-	1387	1942	
Reverse transfer capacitance	C _{rss}			-	66	93	
Total gate charge ^c	Qg			-	46	69	
Gate-source charge ^c	Q _{gs}	V _{GS} = -10 V	$V_{GS} = -10 \text{ V}$ $V_{DS} = -40 \text{ V}, I_D = -15 \text{ A}$		12	-	nC
Gate-drain charge ^c	Q _{gd}				6	-	
Gate resistance	R _q	f = 1 MHz		0.7	1.5	2.3	Ω
Turn-on delay time ^c	t _{d(on)}	V_{DD} = -40 V, R _L = 2.66 Ω, $I_D \cong$ -15 A, V_{GEN} = -10 V, R _g = 1 Ω		-	17	26	
Rise time ^c	t _r			-	5	9	- ns
Turn-off delay time ^c	t _{d(off)}			-	34	51	
Fall time ^c	t _f			-	5	9	
Source-Drain Diode Ratings and Chara	cteristics ^b						
Pulsed current ^a	I _{SM}			-	-	-224	А
Forward voltage	V _{SD}	I _F = -10 A, V _{GS} = 0 V		-	-0.76	-1.2	V
Body diode reverse recovery time	t _{rr}	I _F = -10 A, di/dt = 100 A/μs		-	42	84	ns
Body diode reverse recovery charge	Q _{rr}			-	51	102	nC
Reverse recovery fall time	t _a			-	21	-	ns
Reverse recovery rise time	t _b			-	22	-	

Notes

a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

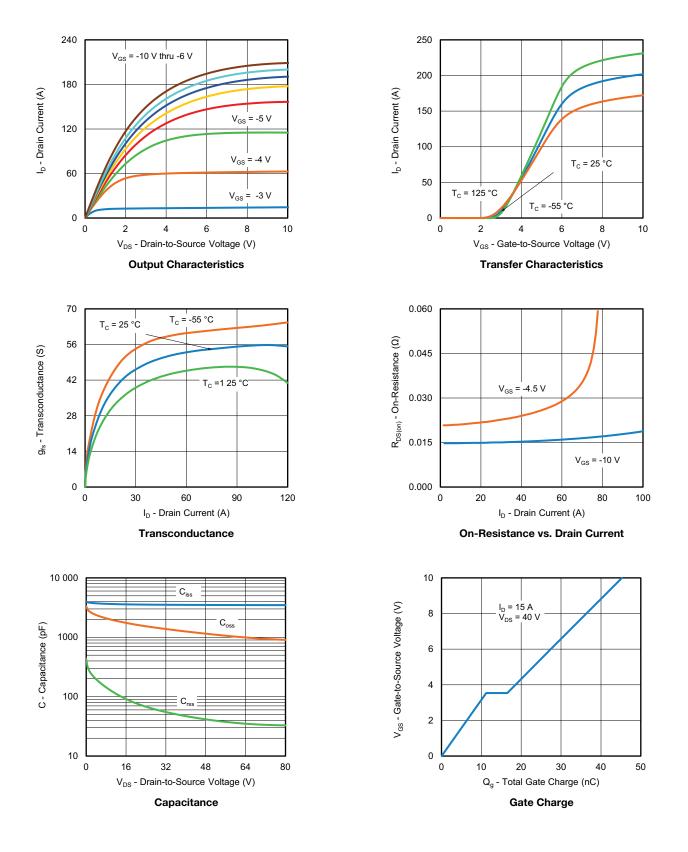
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



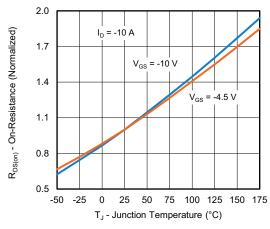
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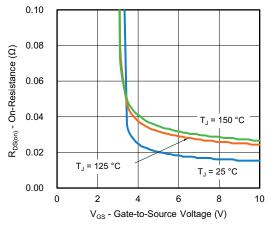


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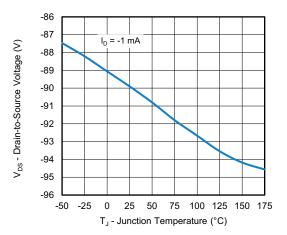
TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



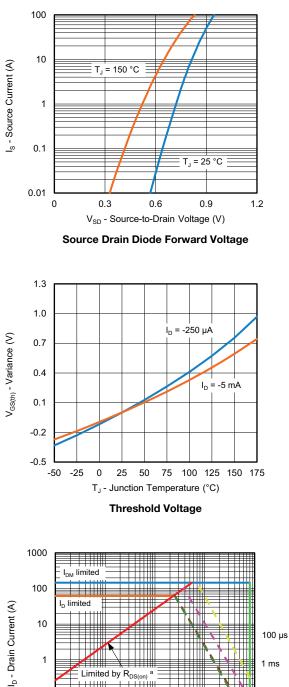
On-Resistance vs. Junction Temperature

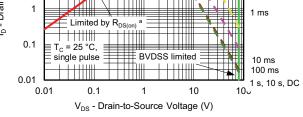


On-Resistance vs. Gate-to-Source Voltage

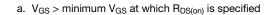


Drain-Source Breakdown vs. Junction Temperature





Safe Operating Area



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Note

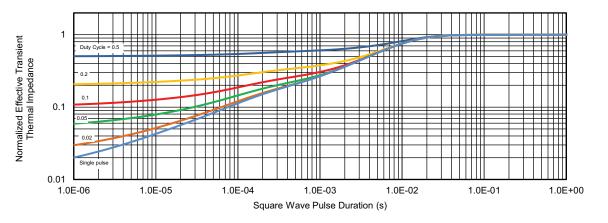
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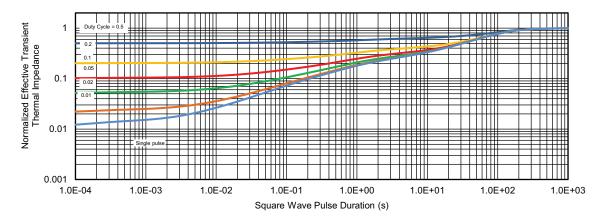


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THERMAL RATINGS (T_C = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case



Normalized Thermal Transient Impedance, Junction-to-Ambient

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?62115.

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